Express Mail Label No. EV608119912US

Docket No.: SUN-0098

FORM PTO-1595 (Modified)	00.00	T US SEDARTHENT OF COMMERCE			
FORM PTO-1595 (Modified) (Rev. 03-01) OMB No. 0651-0027 (exp.5/31/2002)		2005 T U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office			
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To the Director of the United States Patem	102933	attached original documents or copy thereof.			
Name of conveying party(ies):		2. Name and address of receiving party(ies):			
Sung-Mo CHUNG Jong-Seong LEE		Name: SAMSUNG ELECTRONICS CO., LTD.			
Chang-Hwan HWANG					
		Address: 416 Maetan-dong, Yeongtong-gu			
Additional names(s) of conveying party(ies)	☐ Yes ☒ No	1128			
3. Nature of conveyance:					
☑ Assignment ☐ Me	erger				
☐ Security Agreement ☐ Cha	ange of Name	City: Suwon-si State/Prov.: Gyeonggi-do			
Other		Country: Republic of Korea ZIP:			
Execution Date: 12-27-2004		Additional name(s) & address(es) ☐ Yes ☒ No			
Patent Application No. Filing date		B. Patent No.(s)			
	Additional numbers	☐ Yes ☒ No			
Name and address of party to whom corre- concerning document should be mailed:	spondence	6. Total number of applications and patents involved:			
Name: Jae Y. Park		7. Total fee (37 CFR 3.41):\$ 40.00			
Registration No. PLEASE SEE ATTACH	[ED	☐ Enclosed - Any excess or insufficiency should be			
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Jae Y. Park	la	January 17, 2005			
Name of Person Signing	ser of pages including as	Signature Date			

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ASSIGNMENT

WHEREAS We, SUNG-MO CHUNG of 4Fl., 400-8, Jungnim-dong, Jung-gu, Seoul, Rep. of Korea, JONG-SEONG LEE of 102-1003, Samsung Apt., Donam-dong, Sungbuk-gu, Seoul, Rep. of Korea and CHANG-HWAN HWANG of 542-1302, Eunbit-maeul LG Apt., Hwajeong-dong, Dukyang-gu, Goyang-si, Gyeonggi-do, Rep. of Korea (hereinafter referred to as "ASSIGNORS") have invented certain new and useful improvements in:

COVER FOR CELLULAR PHONE PROVIDED WITH SPEAKER MODULE and for which We have filed an application for Letters Patent of the United States on (Serial No.);

AND WHEREAS, SAMSUNG ELECTRONICS CO., LTD. (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Republic of Korea, is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will, at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

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PATENT REEL: 016205 FRAME: 0282

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date:	2 4.	12.	21)	

Date: Dec. 27. 2004 Chang Hwan L.S.

Date: Dec. 27. 2004 Jong-seong Lee L.S.

Date: Dec. 27. 2004 Chang Hwan L.S.

CHANG-HWANHWANG

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